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FEATURES

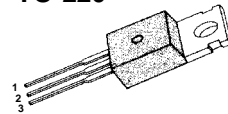
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- 175°C Operating Temperature
- Extended Safe Operating Area
- Lower Leakage Current : -10 μA (Max.) @ $V_{DS} = -100V$
- Low $R_{DS(ON)}$: 0.225 Ω (Typ.)

$$BV_{DSS} = -100 V$$

$$R_{DS(on)} = 0.3 \Omega$$

$$I_D = -10.5 A$$

TO-220



1.Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	-100	V
I_D	Continuous Drain Current ($T_C=25^\circ C$)	-10.5	A
	Continuous Drain Current ($T_C=100^\circ C$)	-7.5	
I_{DM}	Drain Current-Pulsed ①	-42	A
V_{GS}	Gate-to-Source Voltage	±30	V
E_{AS}	Single Pulsed Avalanche Energy ②	368	mJ
I_{AR}	Avalanche Current ①	-10.5	A
E_{AR}	Repetitive Avalanche Energy ①	6.6	mJ
dv/dt	Peak Diode Recovery dv/dt ③	-6.5	V/ns
P_D	Total Power Dissipation ($T_C=25^\circ C$)	66	W
	Linear Derating Factor	0.44	
T_J, T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +175	°C
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	2.27	°C/W
$R_{\theta CS}$	Case-to-Sink	0.5	--	
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

Electrical Characteristics (T_C=25°C unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV _{DSS}	Drain-Source Breakdown Voltage	-100	--	--	V	V _{GS} =0V, I _D =-250μA
ΔBV/ΔT _J	Breakdown Voltage Temp. Coeff.	--	-0.1	--	V/°C	I _D =-250μA See Fig 7
V _{GS(th)}	Gate Threshold Voltage	-2.0	--	-4.0	V	V _{DS} =-5V, I _D =-250μA
I _{GSS}	Gate-Source Leakage, Forward	--	--	-100	nA	V _{GS} =-20V
	Gate-Source Leakage, Reverse	--	--	100		V _{GS} =20V
I _{DSS}	Drain-to-Source Leakage Current	--	--	-10	μA	V _{DS} =-100V
		--	--	-100		V _{DS} =-80V, T _C =150°C
R _{DS(on)}	Static Drain-Source On-State Resistance	--	--	0.3	Ω	V _{GS} =-10V, I _D =-5.3A ④
g _{fs}	Forward Transconductance	--	5.5	--	S	V _{DS} =-40V, I _D =-5.3A ④
C _{iss}	Input Capacitance	--	800	1035	pF	V _{GS} =0V, V _{DS} =-25V, f=1MHz See Fig 5
C _{oss}	Output Capacitance	--	160	240		
C _{rss}	Reverse Transfer Capacitance	--	60	90		
t _{d(on)}	Turn-On Delay Time	--	13	35	ns	V _{DD} =-50V, I _D =-10.5A, R _G =12 Ω See Fig 13 ④⑤
t _r	Rise Time	--	22	55		
t _{d(off)}	Turn-Off Delay Time	--	45	100		
t _f	Fall Time	--	25	60		
Q _g	Total Gate Charge	--	30	38	nC	V _{DS} =-80V, V _{GS} =-10V, I _D =-10.5A See Fig 6 & Fig 12 ④⑤
Q _{gs}	Gate-Source Charge	--	5.4	--		
Q _{gd}	Gate-Drain("Miller") Charge	--	12.2	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I _S	Continuous Source Current	--	--	-10.5	A	Integral reverse pn-diode in the MOSFET
I _{SM}	Pulsed-Source Current ①	--	--	-42		
V _{SD}	Diode Forward Voltage ④	--	--	-4.0	V	T _J =25°C, I _S =-10.5A, V _{GS} =0V
t _{rr}	Reverse Recovery Time	--	120	--	ns	T _J =25°C, I _F =-10.5A
Q _{rr}	Reverse Recovery Charge	--	0.53	--	μC	di _F /dt=100A/μs ④

Notes ;

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② L=5.0mH, I_{AS}=-10.5A, V_{DD}=-25V, R_G=27Ω*, Starting T_J=25°C
- ③ I_{SD} ≤ -10.5A, di/dt ≤ 400A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J=25°C
- ④ Pulse Test : Pulse Width = 250μs, Duty Cycle ≤ 2%
- ⑤ Essentially Independent of Operating Temperature

Fig 1. Output Characteristics

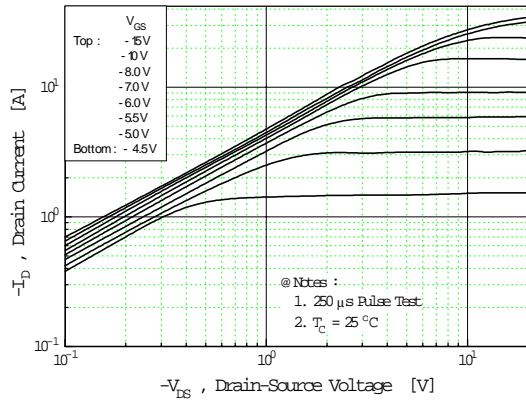


Fig 2. Transfer Characteristics

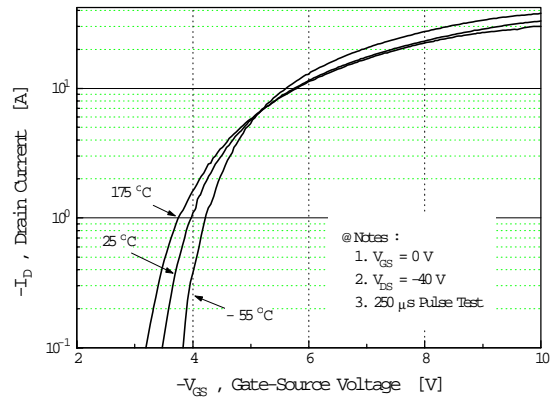


Fig 3. On-Resistance vs. Drain Current

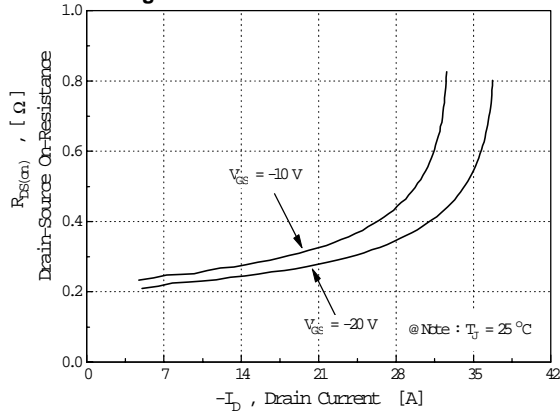


Fig 4. Source-Drain Diode Forward Voltage

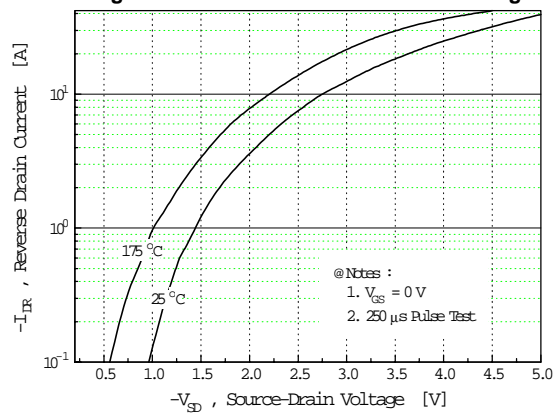


Fig 5. Capacitance vs. Drain-Source Voltage

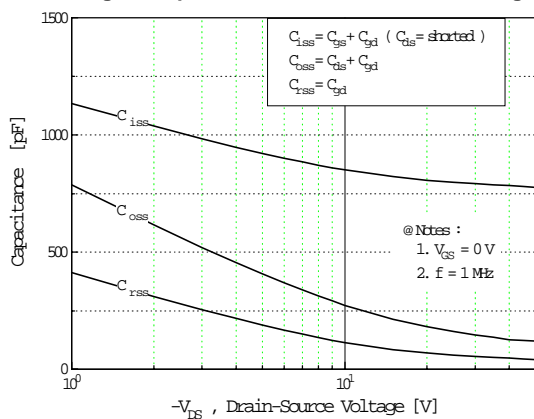


Fig 6. Gate Charge vs. Gate-Source Voltage

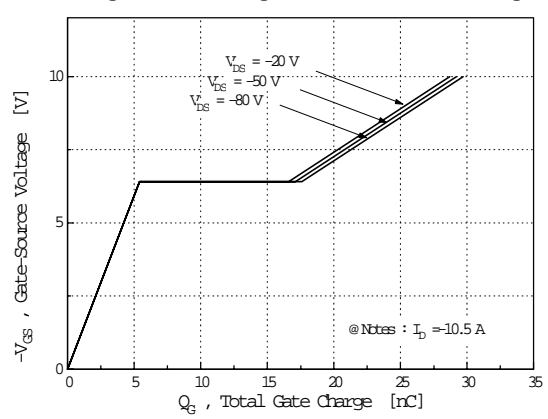


Fig 7. Breakdown Voltage vs. Temperature

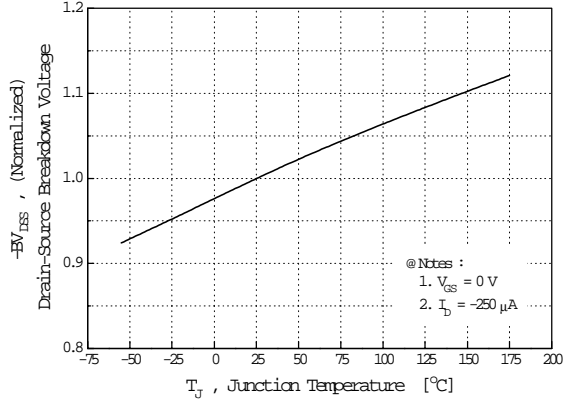


Fig 8. On-Resistance vs. Temperature

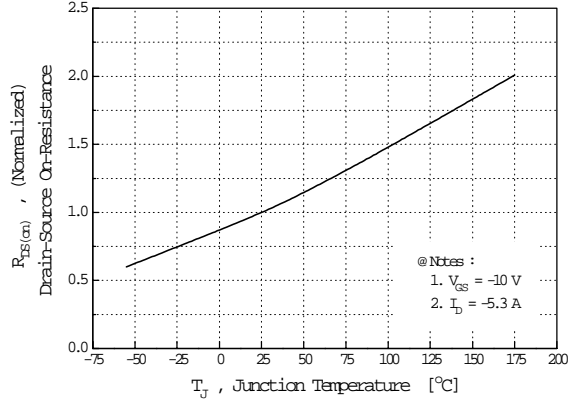


Fig 9. Max. Safe Operating Area

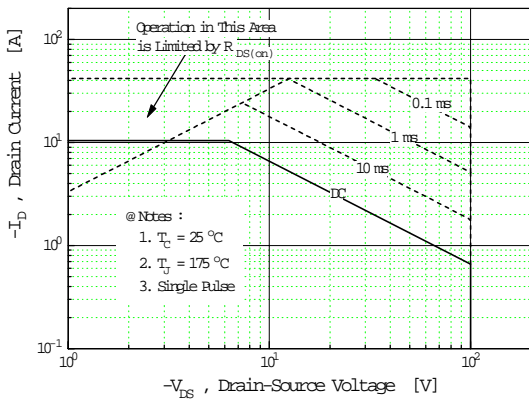


Fig 10. Max. Drain Current vs. Case Temperature

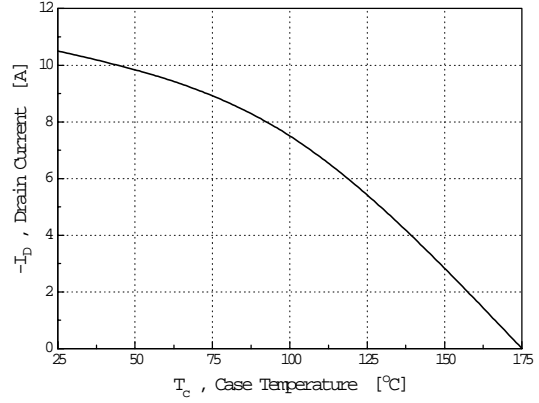


Fig 11. Thermal Response

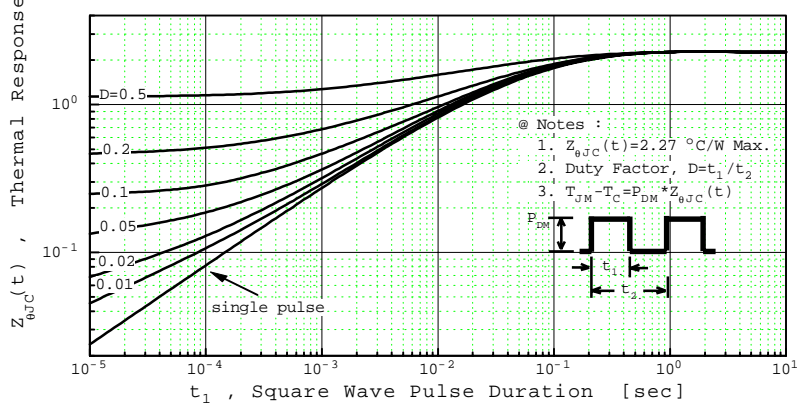


Fig 12. Gate Charge Test Circuit & Waveform

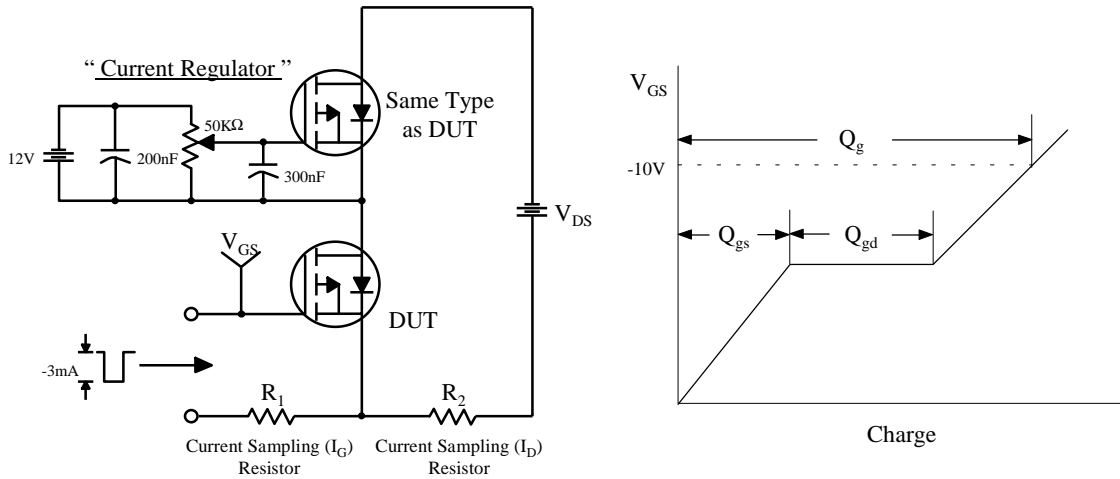


Fig 13. Resistive Switching Test Circuit & Waveforms

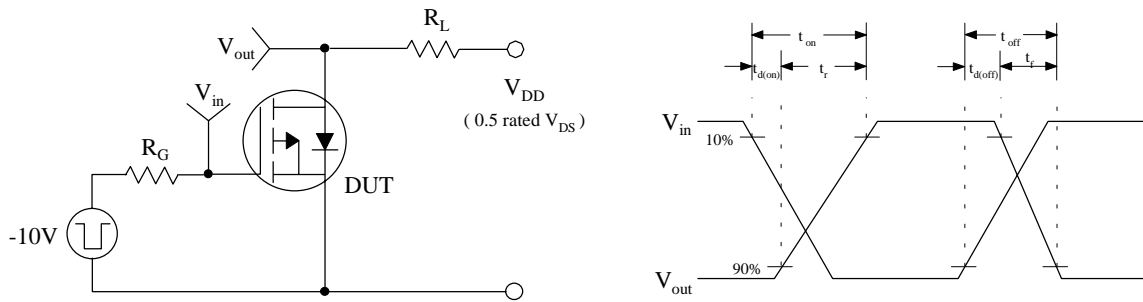
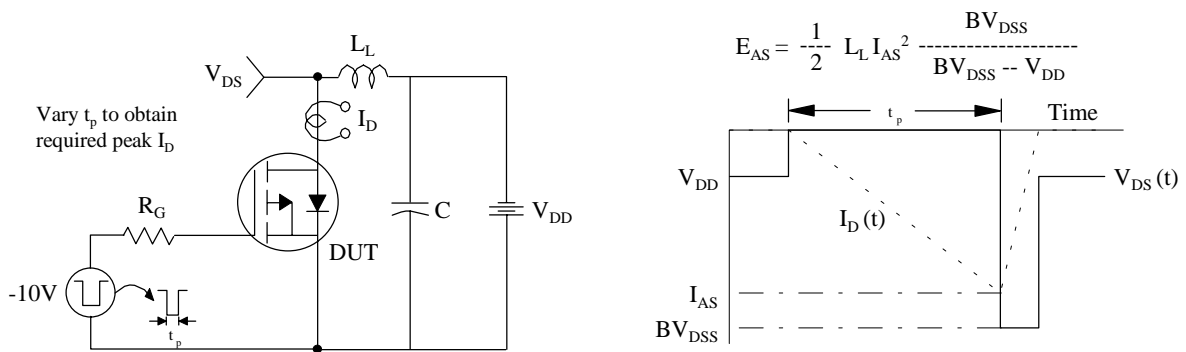


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



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